L Number	Hits	Search Text	DB	Time stamp
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3	4876	((redistribution redistribute redistributed redistributing) and (carrier substrate)) and (bond pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 10:47
4	490795	"4" and (ball bump)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 10:48
5	1564	(((redistribution redistribute redistributed redistributing) and (carrier substrate)) and (bond pad)) and (ball bump)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 10:48
6	230	microelectronic and ((((redistribution redistribute redistributed redistributing) and (carrier substrate)) and (bond pad)) and (ball bump))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 11:52
7	1334	((((redistribution redistribute redistributed redistributing) and (carrier substrate)) and (bond pad)) and (ball bump)) not (microelectronic and ((((redistribution redistribute redistributed redistributing) and (carrier substrate)) and (bond pad)) and (ball bump)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 11:52
8	113421	active and inactive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 11:52
9	158	(((((redistribution redistribute redistributed redistributing) and (carrier substrate)) and (bond pad)) and (ball bump)) not (microelectronic and ((((redistribution redistribute redistributed redistributing) and (carrier substrate)) and (bond pad)) and (ball bump)))) and (active and inactive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 11:54
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4	490795	"4" and (ball bump)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/22 10:48
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